

## Features

- Compliant to USB specifications
- Dual independent switches control
- 2.7V to 5.5V input voltage
- 500mA minimum continuous current per port
- 110mΩ typical on-resistance
- 1.25A maximum short circuit current limit
- Independent open-drain fault flag pins
- 110μA typical on-state supply current
- 1μA typical off-state supply current
- Output can be forced higher than input (off-state)
- Thermal shutdown
- 2.4V typical under voltage lockout (UVLO)
- 1ms turn-on (soft-start) and fast turn-off
- Enable active-high (H) or active-low (L)
- SOP-8L: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

## General Description

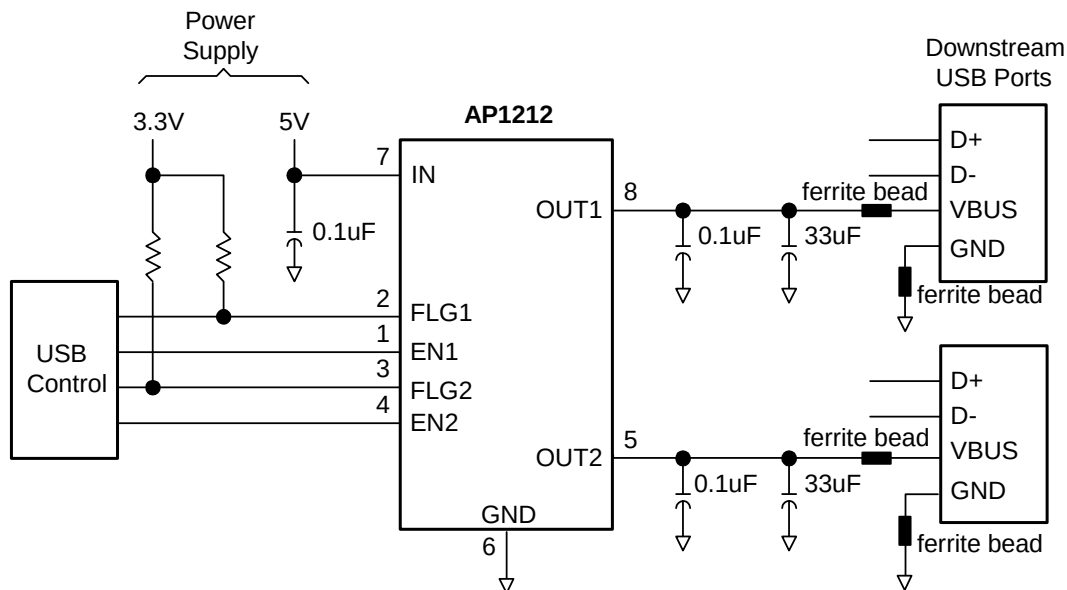
The AP1212 series are dual integrated high-side power switch with independent enable and flag functions, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The AP1212 series support the following USB requirements: each switch channel supplies up to 500mA as required by USB downstream devices; the switch's low on-resistance meets USB voltage drop requirements; fault current is limited to typically 1000mA, well below the UL 25VA safety requirements; and a flag output is available to indicate fault conditions to the local USB controller. Soft start eliminates the momentary voltage drop on the upstream port that may occur when the switch is enabled in bus-powered applications.

Additional features include thermal shutdown to prevent catastrophic switch failure from high-current loads, under voltage lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present, and 3.3V and 5V logic compatible enable inputs.

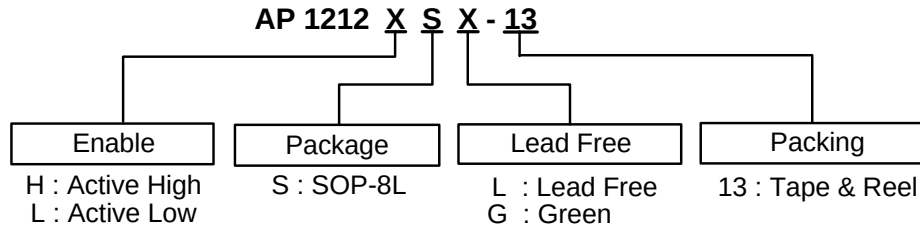
## Applications

- USB hubs
- Hot plug-in power supplies
- Battery-charger circuits

## Typical Application Circuit



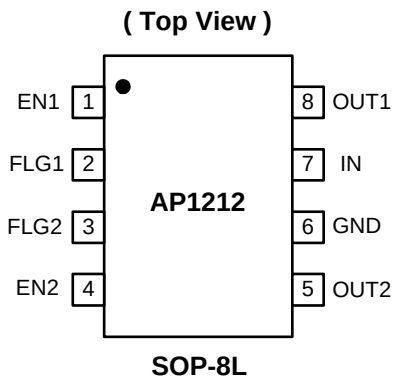
## Ordering Information



| Device       | Package Code | Packaging (Note 2) | 13" Tape and Reel |                    |
|--------------|--------------|--------------------|-------------------|--------------------|
|              |              |                    | Quantity          | Part Number Suffix |
| AP1212XSL-13 | S            | SOP-8L             | 2500/Tape & Reel  | -13                |
| AP1212XSG-13 | S            | SOP-8L             | 2500/Tape & Reel  | -13                |

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at [http://www.diodes.com/products/lead\\_free.html](http://www.diodes.com/products/lead_free.html).  
2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

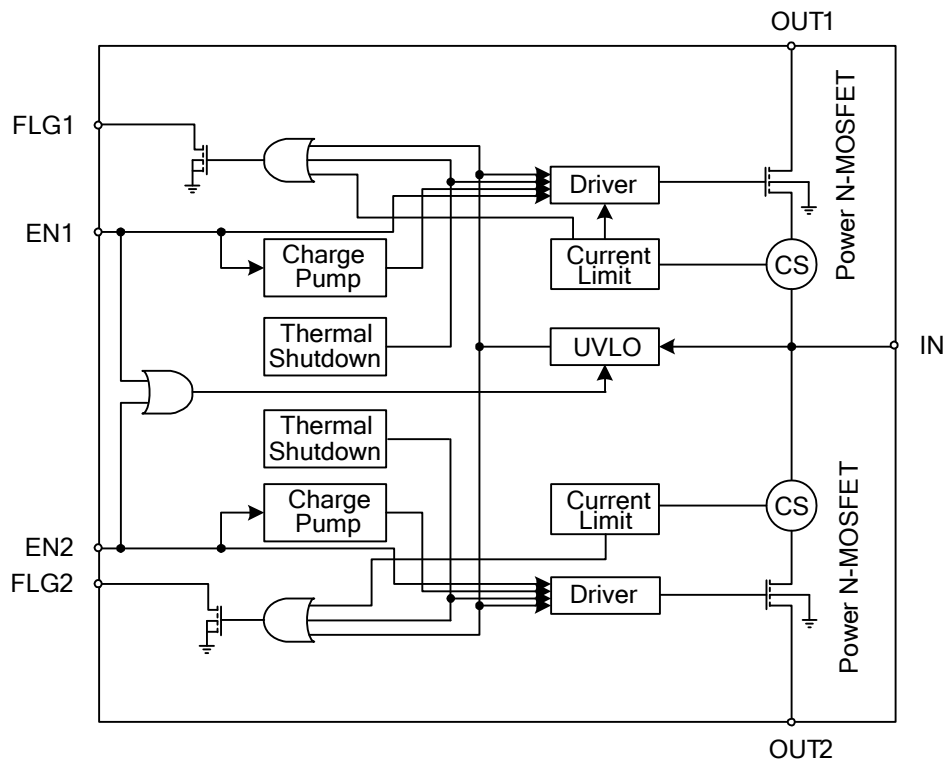
## Pin Assignments



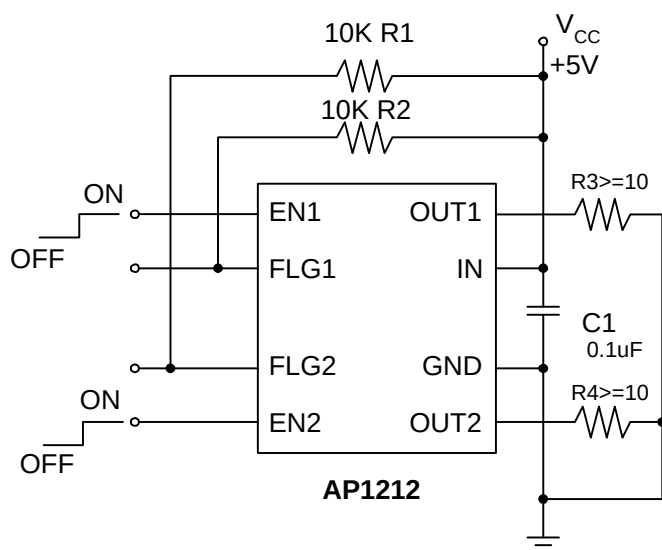
## Pin Descriptions

| Pin Name     | Description                                                                                           |
|--------------|-------------------------------------------------------------------------------------------------------|
| EN1<br>EN2   | Enable: Logic-compatible enable input. (H: active high, L: active low). Do not float.                 |
| FLG1<br>FLG2 | Fault Flag: Active-low, open-drain output. Indicates over current, UVLO, and thermal shutdown.        |
| GND          | Supply return.                                                                                        |
| IN           | Supply Input: Output MOSFET drain. Also supplies IC's internal circuitry. Connect to positive supply. |
| OUT1<br>OUT2 | Switch Output: Output MOSFET source. Typically connect to switched side of load.                      |

## Block Diagram



## Test Circuit (Note 3)



Notes: 3. Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

### Absolute Maximum Ratings (Note 4)

| Symbol    | Parameter                                | Rating               | Unit |
|-----------|------------------------------------------|----------------------|------|
| ESD HBM   | Human Body Model ESD Protection (Note 5) | 500                  | V    |
| ESD MM    | Machine Model ESD Protection (Note 5)    | 150                  | V    |
| $V_{IN}$  | Supply Voltage                           | +7                   | V    |
| $V_{FLG}$ | Fault Flag Voltage                       | +7                   | V    |
| $I_{FLG}$ | Fault Flag Current                       | 50                   | mA   |
| $V_{OUT}$ | Output Voltage                           | +7                   | V    |
| $V_{EN}$  | Control Input Range                      | -0.3 to $V_{IN} + 2$ | V    |
| $T_{ST}$  | Storage Temperature                      | -65 to +150          | °C   |
| MSL       | Moisture Sensitivity Level               | 3                    | -    |

### Recommended Operating Conditions (Note 6)

| Symbol   | Parameter                     | Min | Max | Unit |
|----------|-------------------------------|-----|-----|------|
| $V_{IN}$ | Supply Voltage                | 2.7 | 5.5 | V    |
| $T_A$    | Operating Ambient Temperature | -40 | 125 | °C   |

Notes:

- Exceeding the absolute maximum rating may damage the device.
- Devices are ESD sensitive. Handling precautions are recommended. Human Body model, tested per JEDEC 22-A114. Machine model, tested per JEDEC 22-A115.
- The device is not guaranteed to function outside its operating rating.

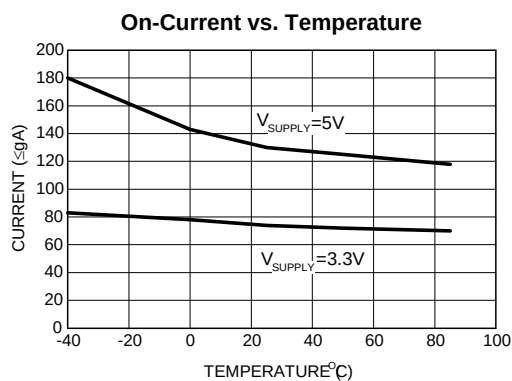
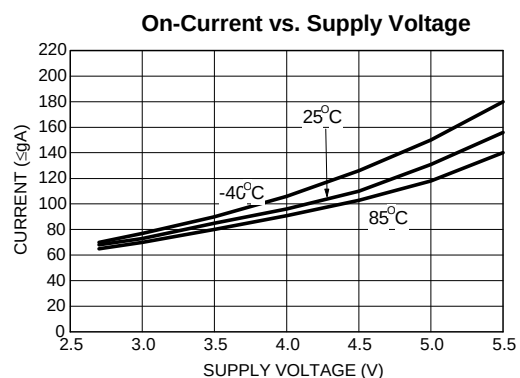
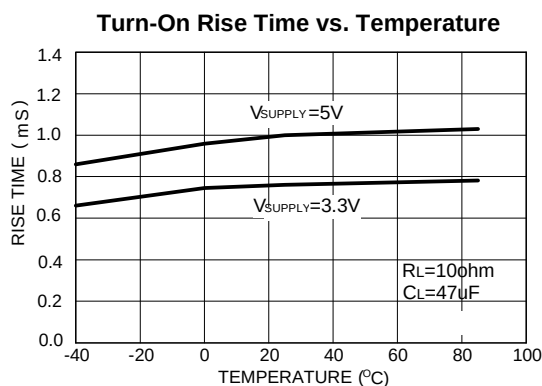
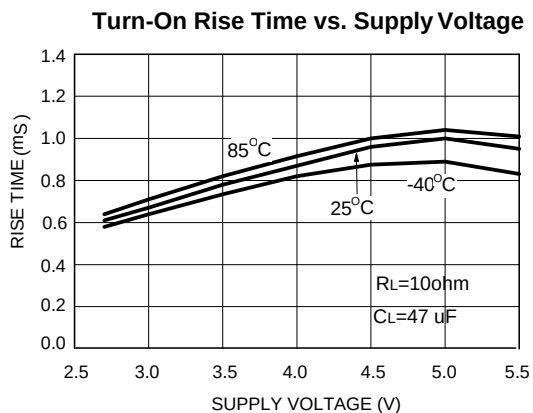
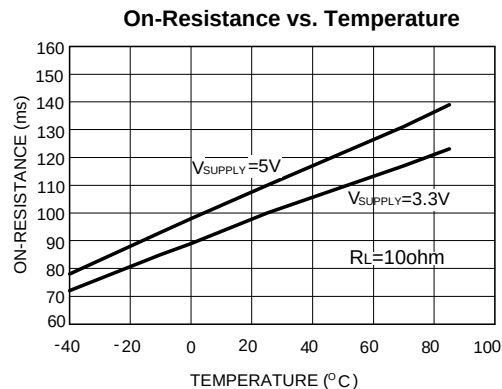
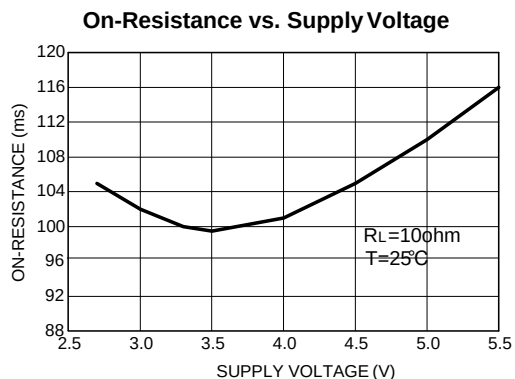
### Electrical Characteristics

(Under the conditions of  $V_{IN} = +5V$  and  $T_A = 25^{\circ}C$ , unless otherwise specified)

| Symbol        | Parameter                              | Conditions                                                  | Min | Typ.       | Max  | Unit          |
|---------------|----------------------------------------|-------------------------------------------------------------|-----|------------|------|---------------|
| $I_{CC}$      | Supply Current                         | Switch off, OUT = open (Note 7)                             |     | 0.50       | 5    | $\mu A$       |
|               |                                        | All switches on, OUT = open (Note 7)                        |     | 110        | 160  | $\mu A$       |
| $V_{IT}$      | Enable Input Threshold                 | (Note 7)                                                    | 0.8 | 1.7        | 2.40 | V             |
| $I_{EN}$      | Enable Input Current                   | $V_{EN} = 0V$ to 5.5V                                       | -1  | $\pm 0.01$ | 1    | $\mu A$       |
| $C_{EN}$      | Enable Input Capacitance               |                                                             |     | 1          |      | pF            |
| $R_{DS(ON)}$  | Switch Resistance                      | $V_{IN} = 2.7V \sim 5.5V$ , $I_{OUT} = 500mA$ , each switch |     | 110        | 140  | m $\Omega$    |
| $T_{OND}$     | Output Turn-On Delay                   | $R_L = 10\Omega$ each output                                |     | 30         |      | $\mu S$       |
| $T_R$         | Output Turn-On Rise Time               | $R_L = 10\Omega$ each output                                |     | 1          |      | mS            |
| $T_{OFFD}$    | Output Turnoff Delay                   | $R_L = 10\Omega$ each output                                |     | 0.5        | 10   | $\mu S$       |
| $T_F$         | Output Turnoff Fall Time               | $R_L = 10\Omega$ each output                                |     | 0.5        | 10   | $\mu S$       |
| $I_{LEAK}$    | Output Leakage Current                 | Each output (output disabled)                               |     |            | 10   | $\mu A$       |
| $I_{OUT}$     | Continuous Load Current                | Each output                                                 | 0.6 |            |      | A             |
| $I_{OS}$      | Short-circuit Current Limit            | Each output (enable into load), $V_{OUT} = 0V$              | 0.8 | 1.0        | 1.25 | A             |
| $I_{LIM}$     | Current-Limit Threshold                | Ramped load applied to enabled output                       | 1.0 | 1.2        | 1.4  | A             |
| $T_{TS}$      | Over-temperature Shutdown Threshold    | $T_J$ increasing                                            |     | 140        |      | $^{\circ}C$   |
|               |                                        | $T_J$ decreasing                                            |     | 130        |      | $^{\circ}C$   |
| $R_{FO}$      | Error Flag Output Resistance           | $V_{IN} = 5V$ , $I_L = 10mA$                                |     | 10         | 25   | $\Omega$      |
|               |                                        | $V_{IN} = 3.3V$ , $I_L = 10mA$                              |     | 15         | 40   | $\Omega$      |
| $I_{FOH}$     | Error Flag Off Current                 | $V_{FLAG} = 5V$                                             |     | 0.01       | 1    | $\mu A$       |
| UVLO          | UVLO Threshold                         | $V_{IN} =$ increasing                                       |     | 2.5        |      | V             |
|               |                                        | $V_{IN} =$ decreasing                                       |     | 2.3        |      | V             |
| $\theta_{JA}$ | Thermal Resistance Junction-to-Ambient | SOP-8L                                                      |     | 165        |      | $^{\circ}C/W$ |
| $\theta_{JC}$ | Thermal Resistance Junction-to-Case    | SOP-8L                                                      |     | 26         |      | $^{\circ}C/W$ |

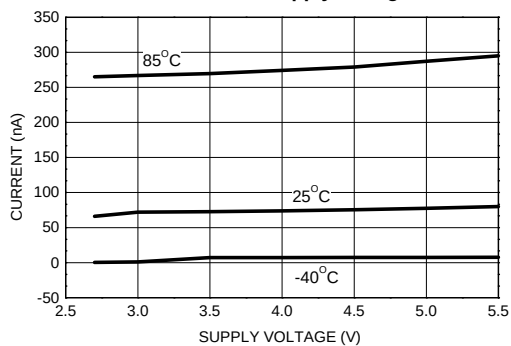
Notes: 7. Off is  $V_{EN} \leq 0.8V$  and on is  $V_{EN} \geq 2.4V$  for the AP1212H. Off is  $V_{EN} \geq 2.4V$  and on is  $V_{EN} \leq 0.8V$  for the AP1212L.

## Typical Performance Characteristics

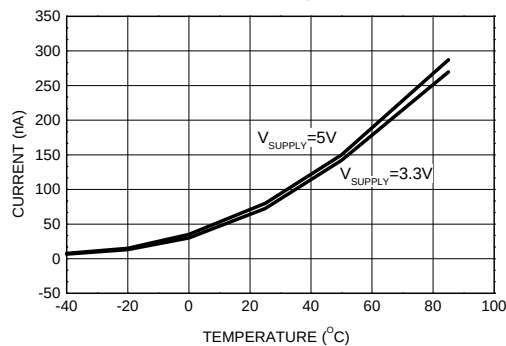


**Typical Performance Characteristics (Continued)**

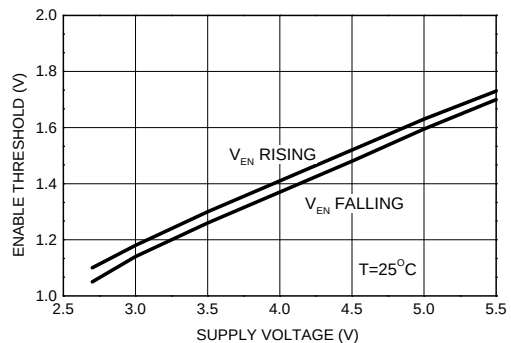
**Off-Current vs. Supply Voltage**



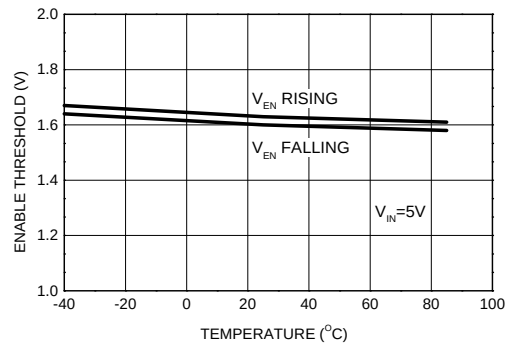
**Off-Current vs. Temperature**



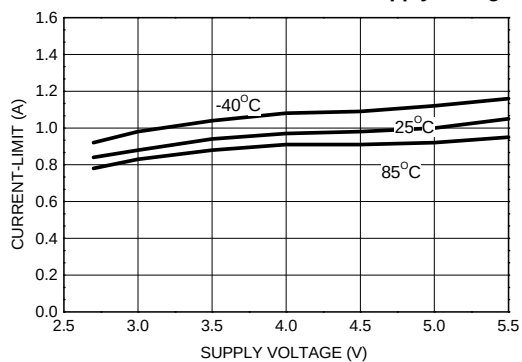
**Enable Threshold vs. Supply Voltage**



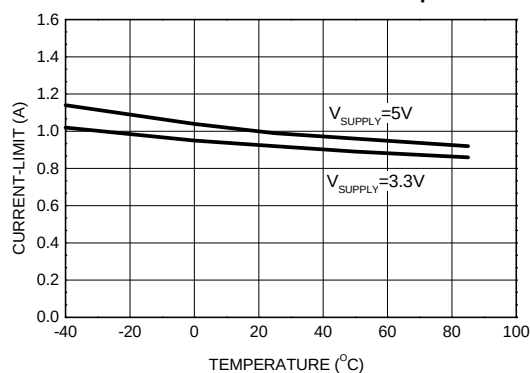
**Enable Threshold vs. Temperature**



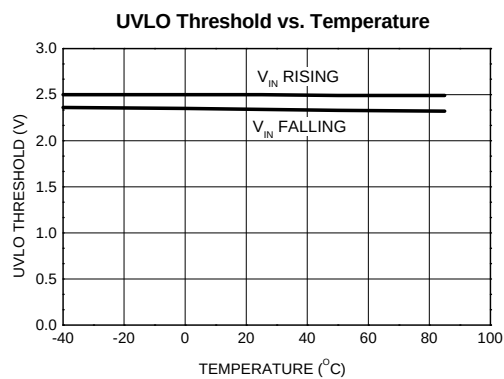
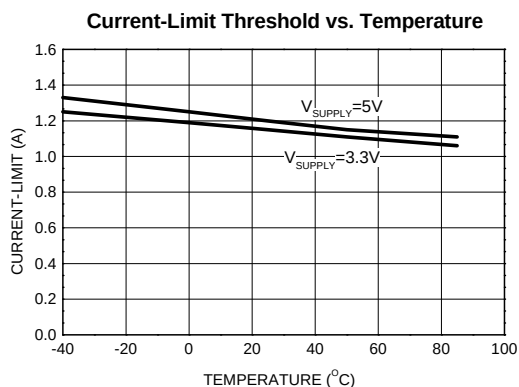
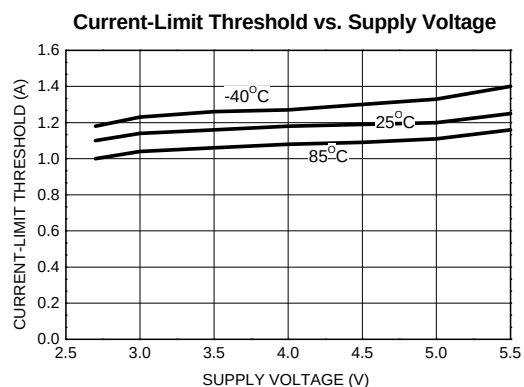
**Short-Circuit Current-Limit vs. Supply Voltage**



**Short-Circuit Current-Limit vs. Temperature**



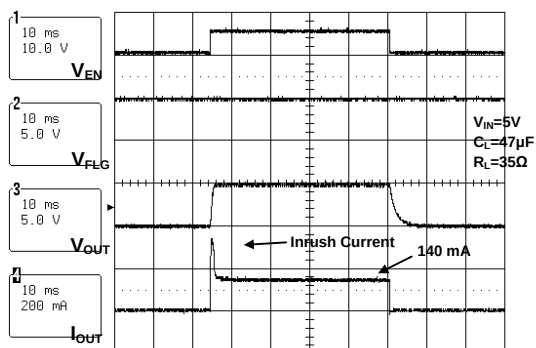
**Typical Performance Characteristics (Continued)**





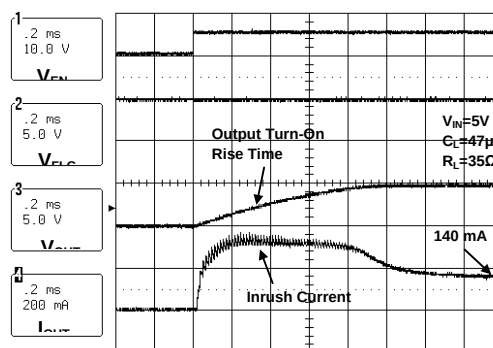
**Typical Performance Characteristics (Continued)**

**Turn-On/Turn-Off (AP1212H)**



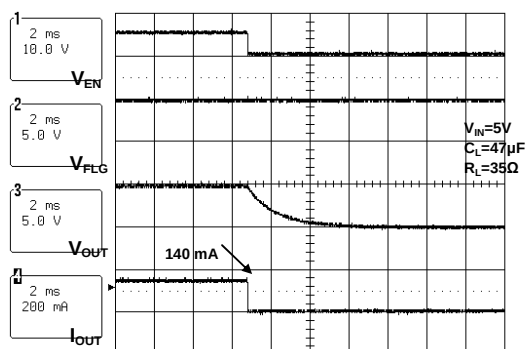
TIME (10ms/div.)

**Turn-On (AP1212H)**



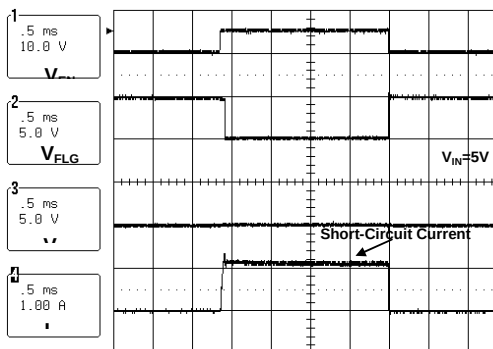
TIME (200μS/div.)

**Turn-Off (AP1212H)**



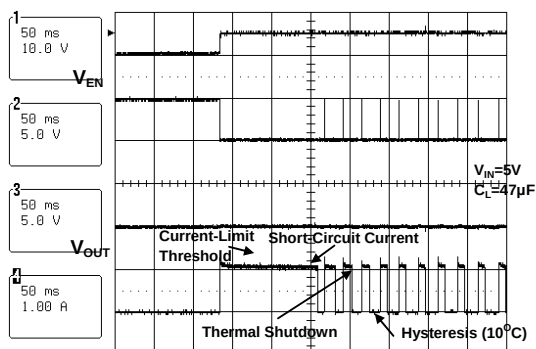
TIME (2ms/div.)

**Enabled Into Short (AP1212H)**



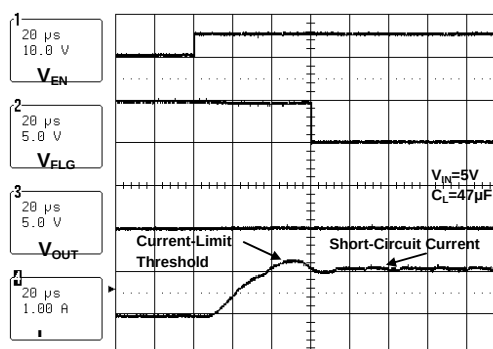
TIME (500μS/div.)

**Current-Limit Response (AP1212H)**



TIME (50ms/div.)

**Current-Limit Response (AP1212H)**



TIME (20μS/div.)

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## Functional Description

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### Error Flag

An open-drained output of N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input under voltage, output current limit, and thermal shutdown.

### Current Limit

The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the AP1212 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

### Thermal Shutdown

When the chip temperature exceeds 140°C for any reason other than over current fault of either one of the two MOSFET switches, the thermal shutdown function turns off both MOSFET switches and signals the error flag. A hysteresis of 10°C prevents the MOSFETs from turning back on until the chip temperature drops to below 130°C.

### Enable

Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

### Supply Filtering

A 0.1μF to 1μF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

### Transient Droop Requirements

USB applications support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

### Short Circuit Transient

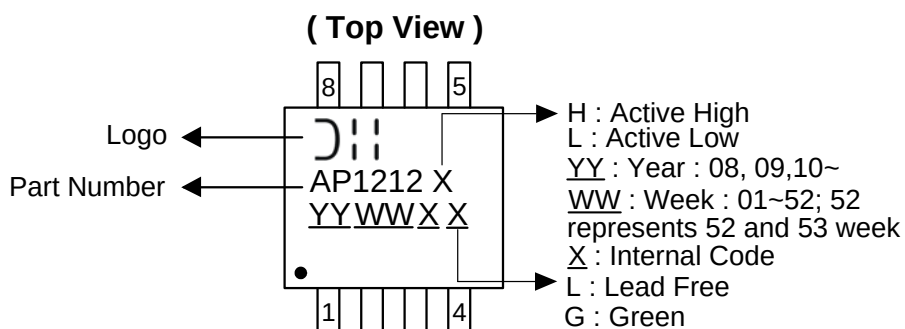
Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a 33μF, 16V tantalum or 100μF, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

### Printed Circuit Layout

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

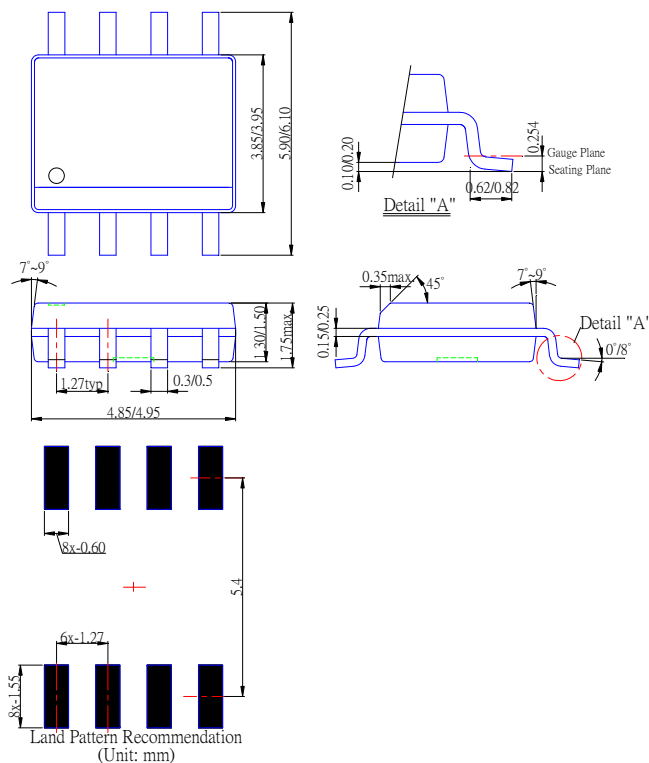
## Marking Information

### (1) SOP-8L



## Package Information (All Dimensions in mm)

### (1) Package Type: SOP-8L



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